

RIBBON CABLE CONNECTORS



✓ Active

TE CONNECTIVITY (TE)

IDC LOW PRO HDR 10P RA HT BLACK

AMP-LATCH | Low Profile Headers

1761682-3

TE Internal Number: 1761682-3

EU RoHS Compliant EU ELV Compliant

Connector System Wire-to-Board

Number of Positions 10

Centerline (Pitch) 2.54 mm [.1 in]

PCB Mount Retention Without

PCB Mounting Orientation Right Angle



PRODUCT DRAWING

English



★ 3D PDF

DOCUMENTATION

Product Drawings

HEADER ASSEMBLY, HIGH TEMP, RIGHT ANGLE, LOW PROFILE, IDC

PDF

English

CAD Files

3D PDF

PDF

3D

Customer View Model

2D_DXF.ZIP

English

Customer View Model 3D_IGS.ZIP **English Customer View Model** 3D_STP.ZIP **English Product Specifications Product Specification** AMP-LATCH And IDC Header Connectors, .100 X .100 Inch Grid **PDF English** Product Environmental Compliance TE Material Declaration MD_1761682-3_092220132322_dmtec **PDF English FEATURES** Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity. **Product Type Features Header Type** Pin Header **Connector System** Wire-to-Board **PCB Mounting Orientation** Right Angle **Shrouded** Yes Row-to-Row Spacing 2.54 mm [.1 in] **Connector Style** Plug **Profile** Low Connector & Contact Terminates To Printed Circuit Board Wire/Cable Type Wave solder capable to 260°C **Connector Type** Header **Board Standoff** Without **Product Type** Connector Configuration Features **Number of Positions** 10 Number of Rows 2 **Ejection Latches** Without **Electrical Characteristics**

Body Features

Operating Voltage (VAC) 250

Insulation Resistance (M Ω) 1000 – 5000

Post Size .64 mm [.025 in]

Daisy Chain With

Contact Features

Solder Tail Contact Plating Material Tin over Nickel

Contact Shape Square

Contact Current Rating (Max) (A) 1

Contact Mating Area Plating Material Gold

Contact Type Pin

Contact Termination Area Plating Thickness 2.54 µm [100 µin]

Contact Base Material Phosphor Bronze

Contact Transmits (Typical) Signal (Data)

Contact Termination Area Plating Material Tin

Contact Mating Area Plating Thickness (µin) 15

Solder Tail Contact Plating Thickness Wave solder capable to 240°C

Termination Features

Termination Method to PC Board Through Hole

Termination Post Length 2.9 mm [.114 in]

Mechanical Attachment

Panel Mount Retention Type Wave solder capable to 240°C

Panel Mount Retention Without

PCB Mount Alignment Without

PCB Mount Retention Without

Mating Alignment Type Center

Mating Connector Lock Without

Mating Alignment With

Mating Retention Without

Polarization With

Housing Features

Centerline (Pitch) 2.54 mm [.1 in]

Housing Entry Style Top

Housing Material PCT

Housing Color Black

Housing Style 4-Sided

Dimensions

Shrouded End Dimension 3.81 mm [.15 in]

Height 8.89 mm [.35 in]

Length 20.32 mm [.8 in]

Usage Conditions

Operating Temperature Range (°C) -65 – 105

Temperature Rating High

Operation/Application

For Use With AMP-Latch Receptacle

Industry Standards

